



Ruttonsha International Rectifier Ltd.

SILICON CONTROLLED RECTIFIERS

High Power Thyristor Hockey Puk Version Q-PUK Series 3500PQ

Types : 3500 PQ 420

FEATURES

- ❖ Center amplifying gate.
- ❖ Metal case with ceramic insulator
- ❖ High profile hockey - puk.

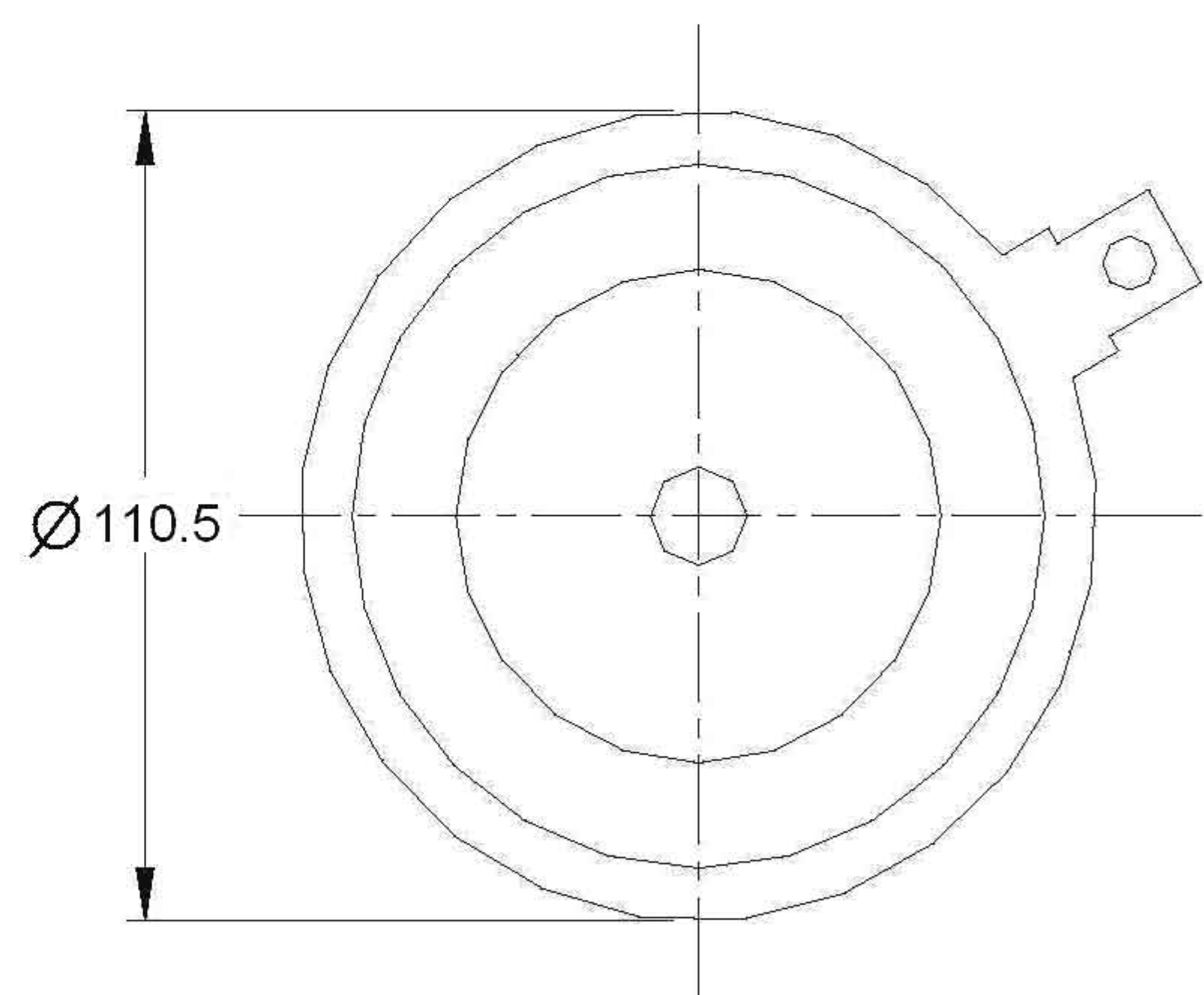
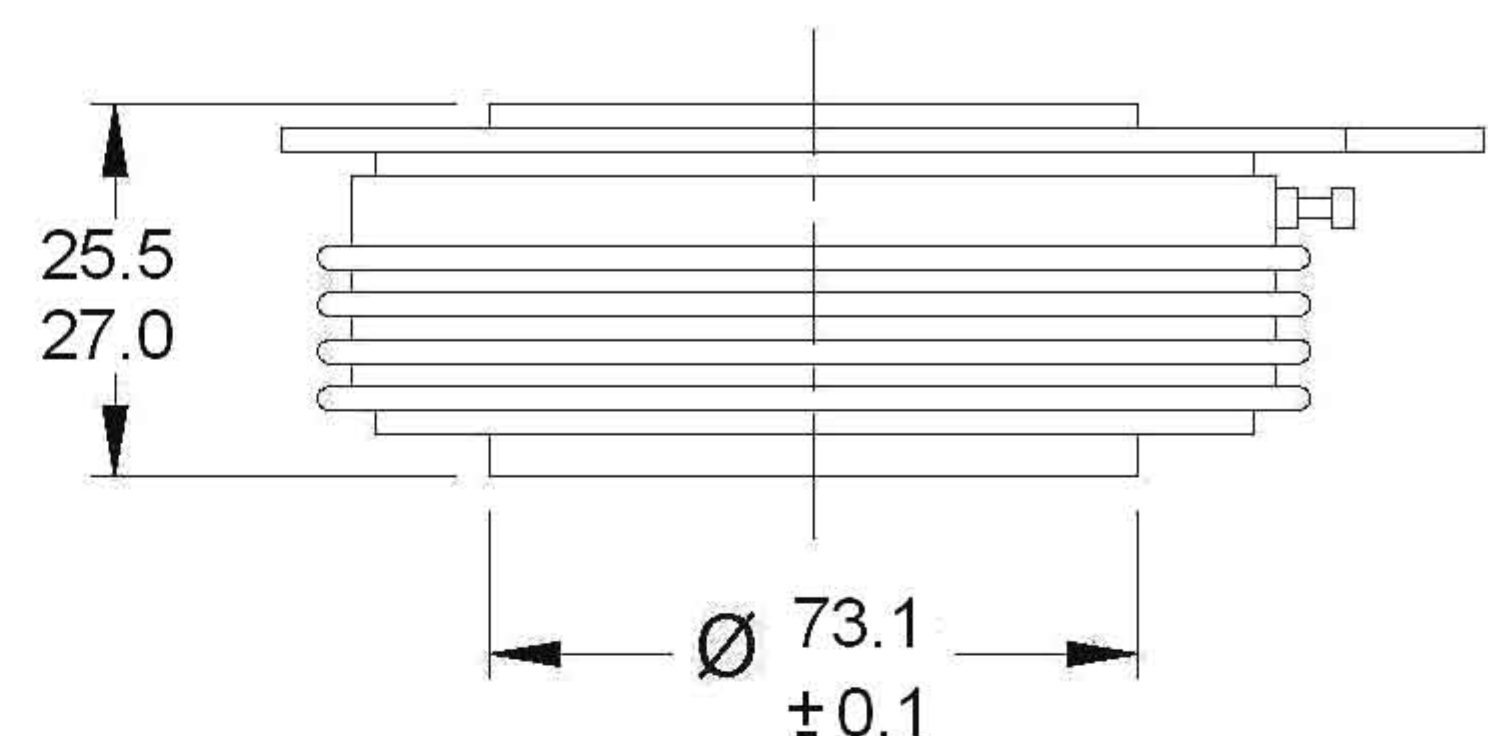
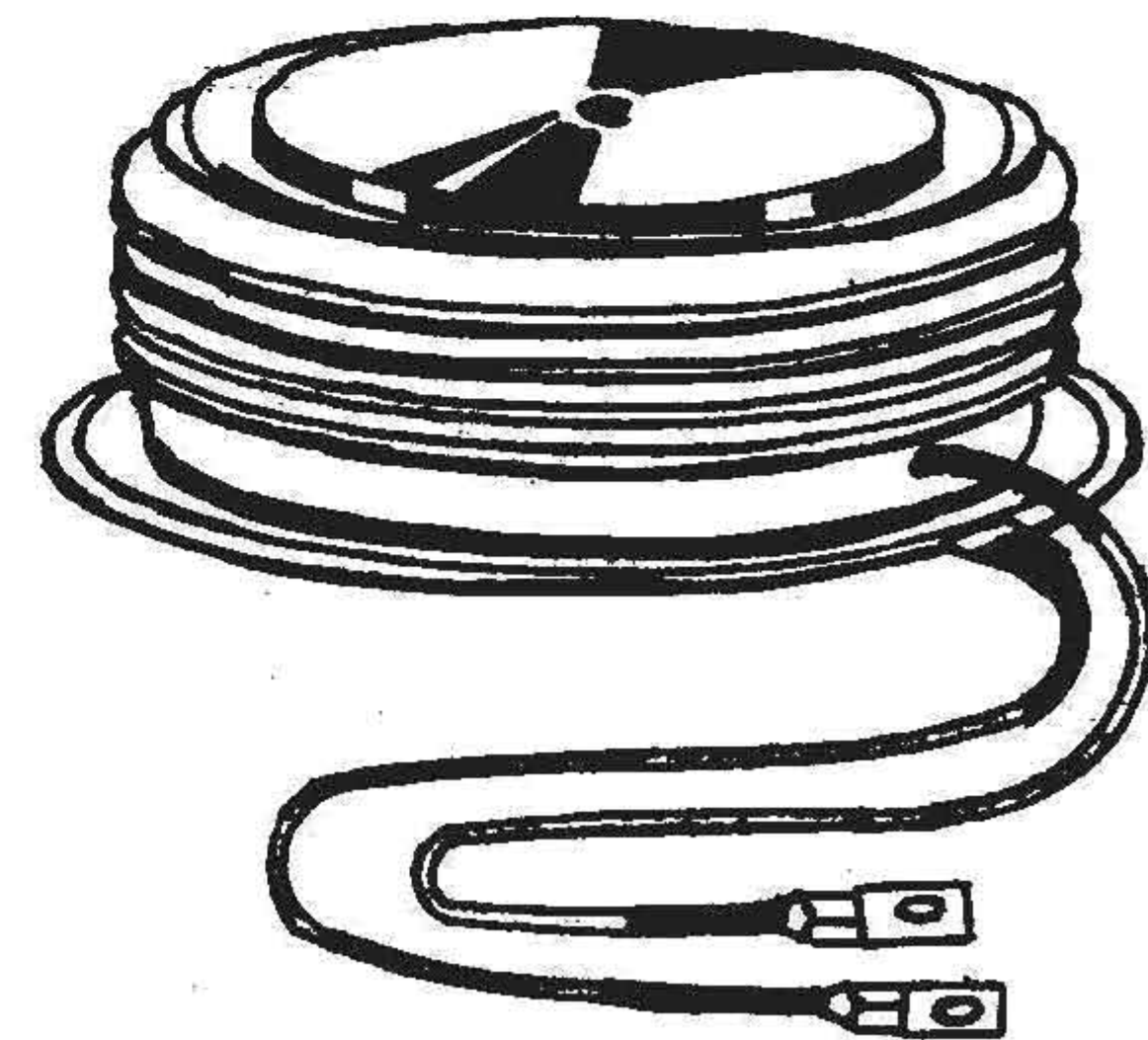
TYPICAL APPLICATIONS

- ❖ DC motor control (e.g. for machine tools).
- ❖ Controlled rectifiers (e.g. for battery charging, Uninterrupted Power Supply).
- ❖ AC controllers (e.g. for temperature control, lights control).

Major Ratings and Characteristics

Parameter	3500PQ	Units
$I_{T(AV)}$	3476	A
@ T_{hs}	55	°C
$I_{T(RMS)}$	6787	A
@ T_{hs}	55	°C
I_{TSM}	52	KA
@ 50 Hz		
I^2t	13520	KA ² s
@ 50 Hz		
V_{DRM}/V_{RRM}	3000 - 4200	V
t_q	typical 550	μs
T_J	-40 to +125	°C

3500 PQ (Q - PUK)



All dimension in millimeters

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ELECTRICAL SPECIFICATIONS

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Voltage Ratings

Type number	Voltage Code	V_{DRM}/V_{RRM} , max repetitive peak and off-state voltage V	V_{RSM} , maximum non-repetitive peak voltage V	I_{DRM}/I_{RRM} max. @ $T_J = T_J$ max. mA
3500PQ	300	3000/3000	3100	250
	320	3200/3200	3300	
	340	3400/3400	3500	
	360	3600/3600	3700	
	400	4000/4000	4100	
	420	4200/4200	4300	

On - state Conduction

Parameter	3500PQ	Units	Conditions
$I_{T(AV)}$ Max. average on-state current @ Heatsink temperature	3476	A	180° conduction, half sine wave
	55	°C	double side cooled
$I_{T(RMS)}$ Max RMS on-state current	6787	A	DC @ 55°C heatsink temperature double side cooled
I_{TSM} Max. peak, one-cycle non-repetitive surge current	52	KA	$t = 10$ ms
			No voltage reappplied
I^2t Maximum I^2t for fusing	13520	KA ² s	$t = 10$ ms
$V_{T(TO)}$ Threshold voltage	0.97	V	$T_J = T_J$ max.
r_t on-state slope resistance	0.18	mΩ	$T_J = T_J$ max.
V_{TM} Max. on state voltage	1.87	V	$I_{PK} = 5000$ A, $T_J = T_J$ max, $t_P = 10$ ms sine pulse
I_H Maximum holding current	1000	mA	$T_J = 25^\circ\text{C}$, anode supply 12 V resistive load

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Switching

Parameter	3500PQ	Units	Conditions
di/dt Max. non-repetitive rate of rise of turned-on current	100	A/μs	Gate drive 20V, 20Ω, $t_r \leq 1\mu s$ $T_J = T_J$ max. anode voltage $\leq 80\% V_{DRM}$
t_q Typical turn-off time	550	μs	$I_{TM} = 4000 A$, $T_J = T_J$ max. di/dt = 10 A/μs, $V_R = 50V$ dv/dt = 20 V/μs, 0.8 V_{DRM} Reapplied, $t_p = 2ms$

Blocking

Parameter	3500PQ	Units	Conditions
dv/dt Maximum critical rate of rise of off-state voltage	500	V/μs	$T_J = T_J$ max. linear to 80% rated V_{DRM}
I_{RRM} I_{DRM} Max. peak reverse and off-state leakage current	250	mA	$T_J = T_J$ max. rated V_{DRM} / V_{RRM} applied

Triggering

Parameter	3500PQ	Units	Conditions
P_{GM} Maximum peak gate power	50	W	$T_J = T_J$ max., $t_p \leq 5 ms$
$P_{G(AV)}$ Maximum average gate power	5		$T_J = T_J$ max., $f = 50Hz$, $d\% = 50$
I_{GM} Max. peak positive gate current	3.0	A	$T_J = T_J$ max., $t_p \leq 5 ms$
$+V_{GM}$ Maximum peak positive gate voltage	20	V	$T_J = T_J$ max., $t_p \leq 5 ms$
$-V_{GM}$ Maximum peak negative gate voltage	5.0		
I_{GT} DC gate current required to trigger	300	mA	$T_J = 25^\circ C$ Max.required gate trigger/ current/voltage are the lowest value which will trigger all units 12 V anode-to-cathode applied
V_{GT} DC gate voltage required to trigger	3.0	V	$T_J = 25^\circ C$
I_{GD} DC gate current not to trigger	10	mA	$T_J = T_J$ max. Max. gate current/voltage not to trigger is the max. value which will not trigger any unit with rated V_{DRM} anode-to-cathode applied
V_{GD} DC gate voltage not to trigger	0.25	V	

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Thermal and Mechanical Specifications

Parameter		3500PQ	Units	Conditions
T _J	Max.operating temperature range	-40 TO +125	°C	
T _{stg}	Max.storage temperature range	-40 TO +150		
R _{thJ-hs}	Max. thermal resistance, junction to heatsink	0.008	K/W	DC operation double side cooled
F	Mounting force, ± 10% ,	63 TO 77	KN	
wt.	Approximate weight	1200	g	
Case style		Q - PUK		See Outline Table

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Type:- 350 PQ Series

Curves

Figure 1 - On-state characteristics of Limit device

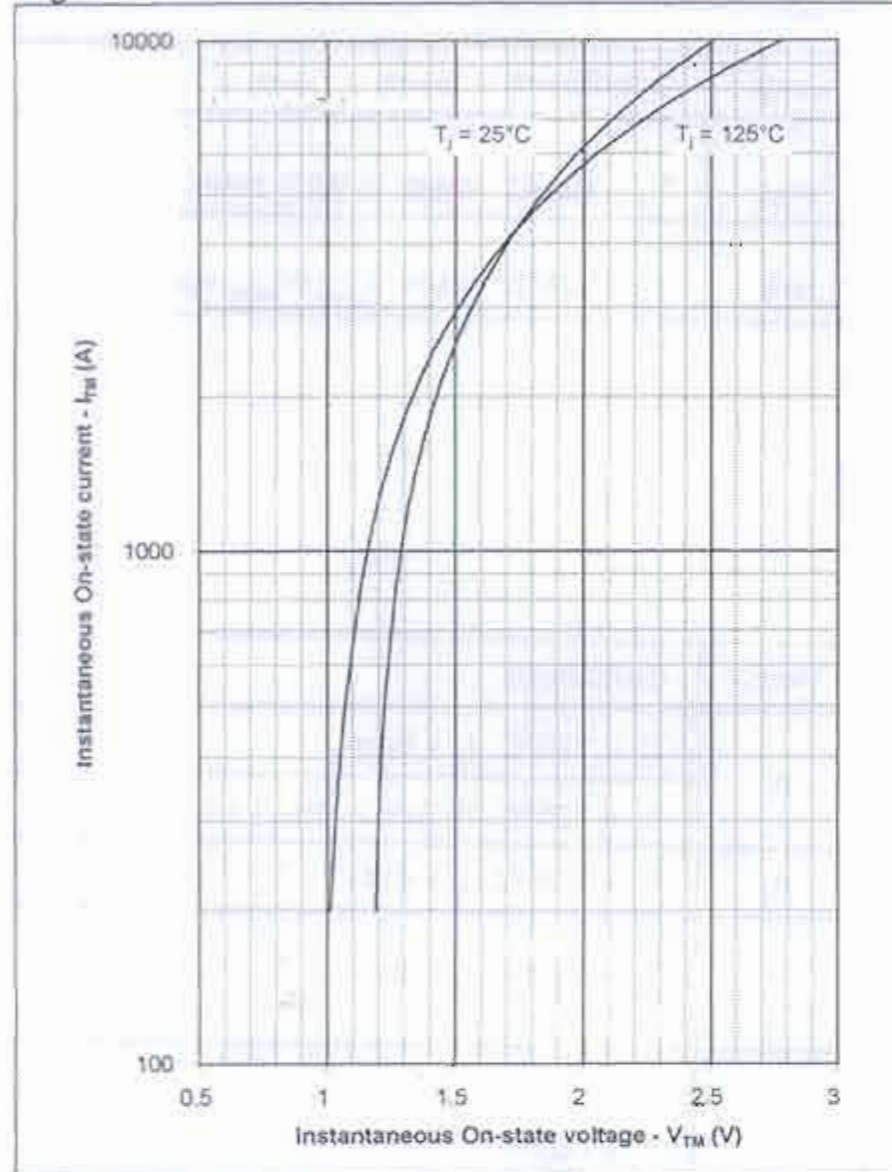


Figure 2 - Transient thermal impedance

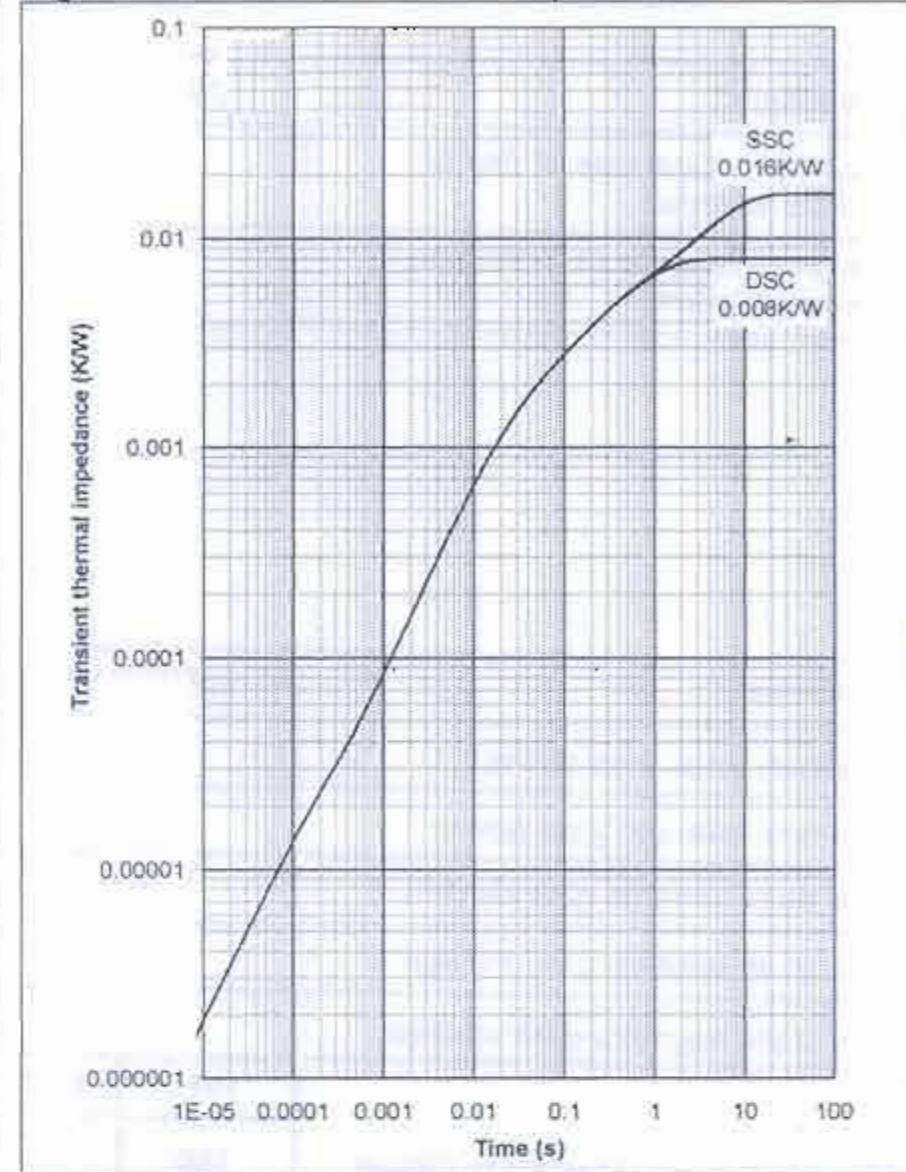


Figure 3 - Gate characteristics - Trigger limits

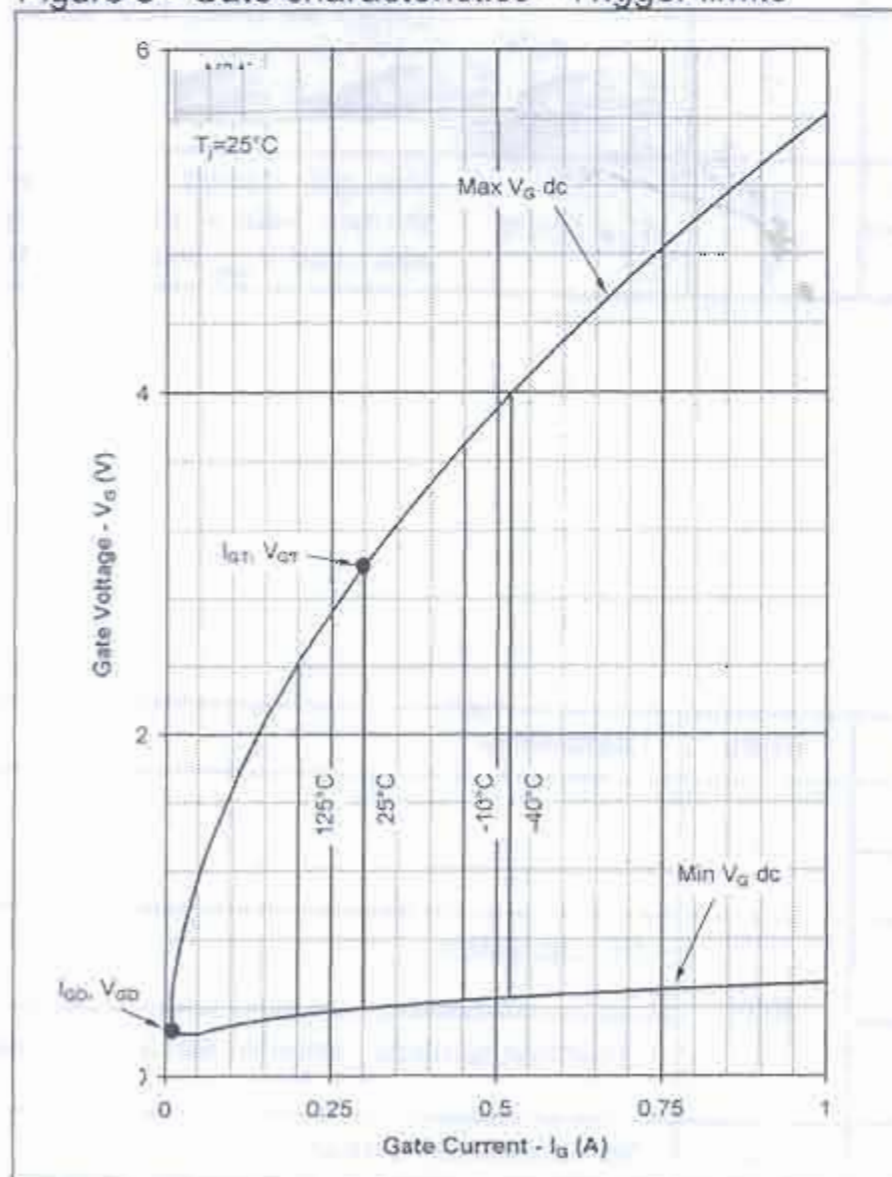
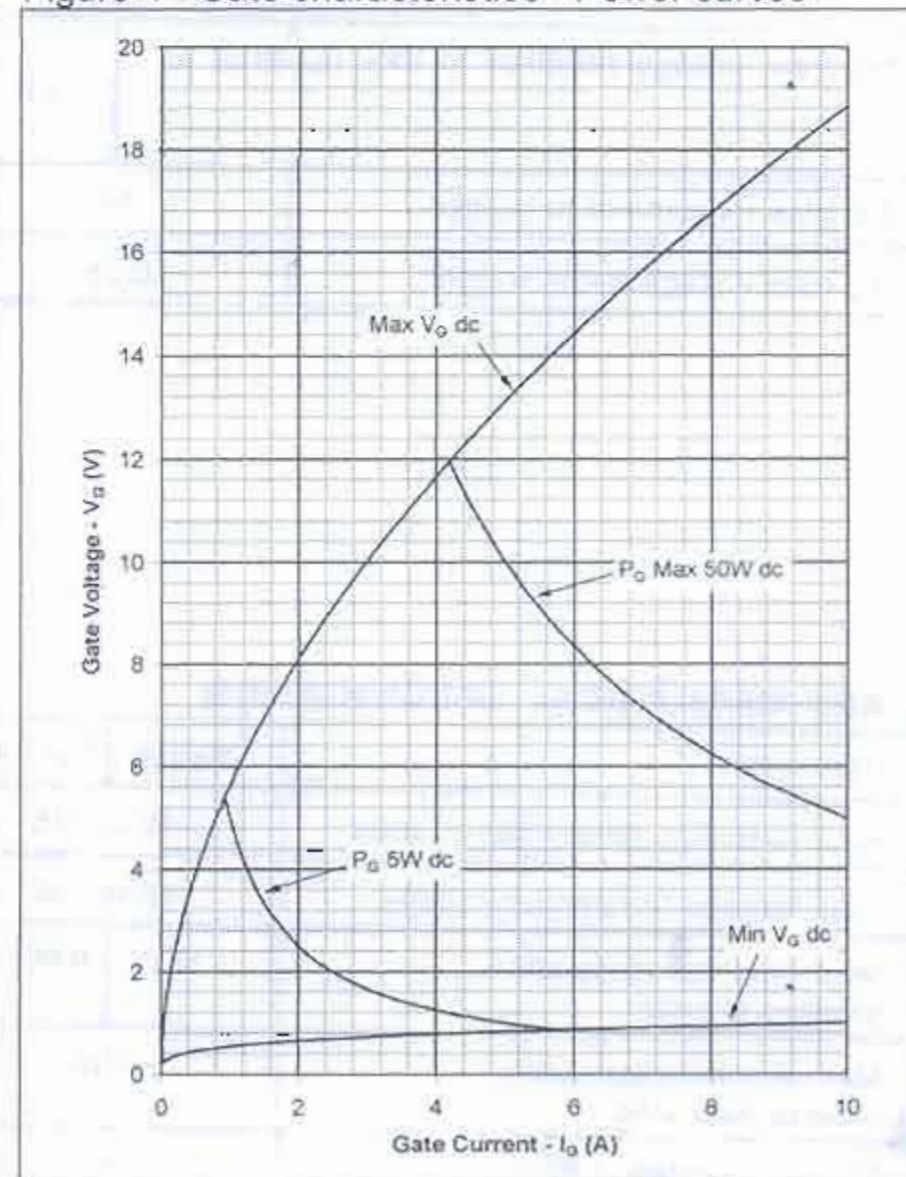


Figure 4 - Gate characteristics - Power curves



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Figure 5 - Total recovered charge, Q_{rr}

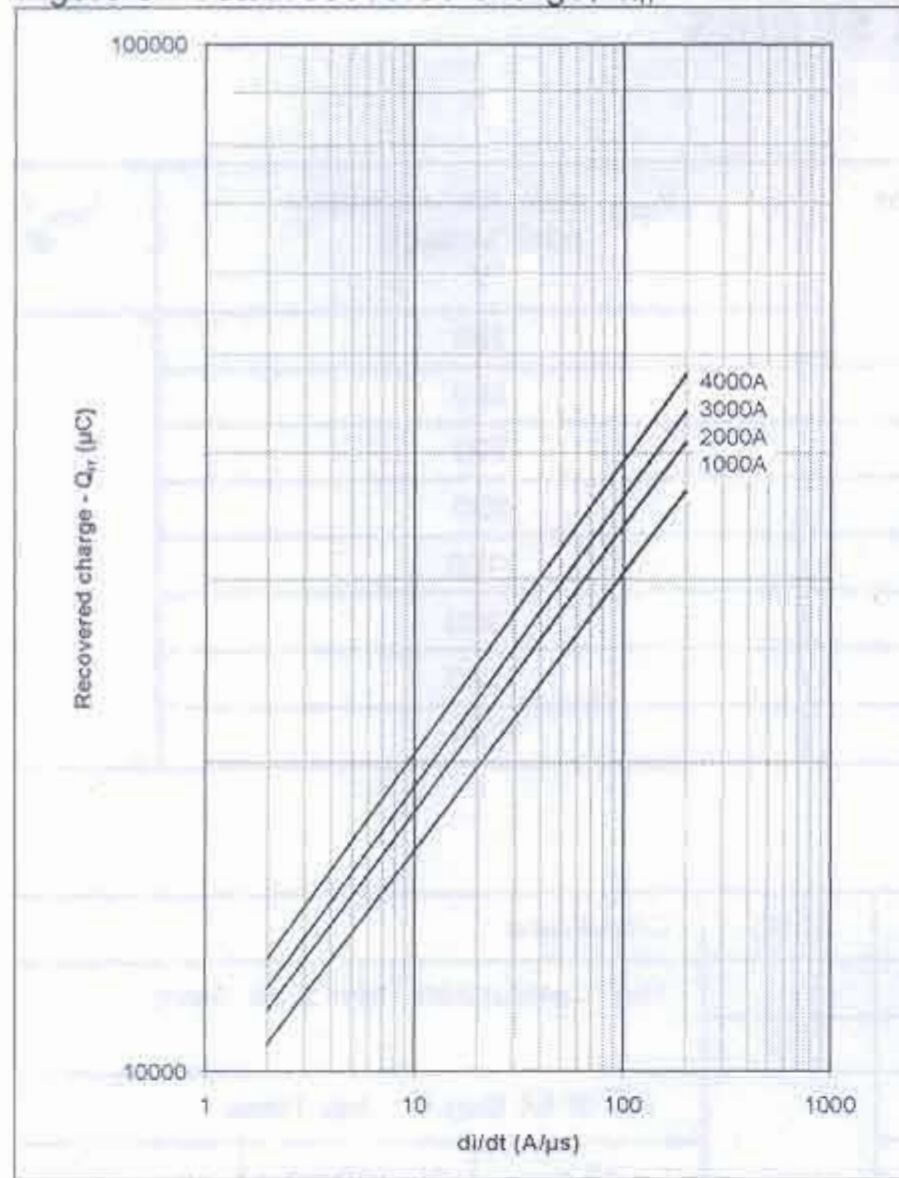


Figure 6 - Recovered charge, Q_{rr} (50% chord)

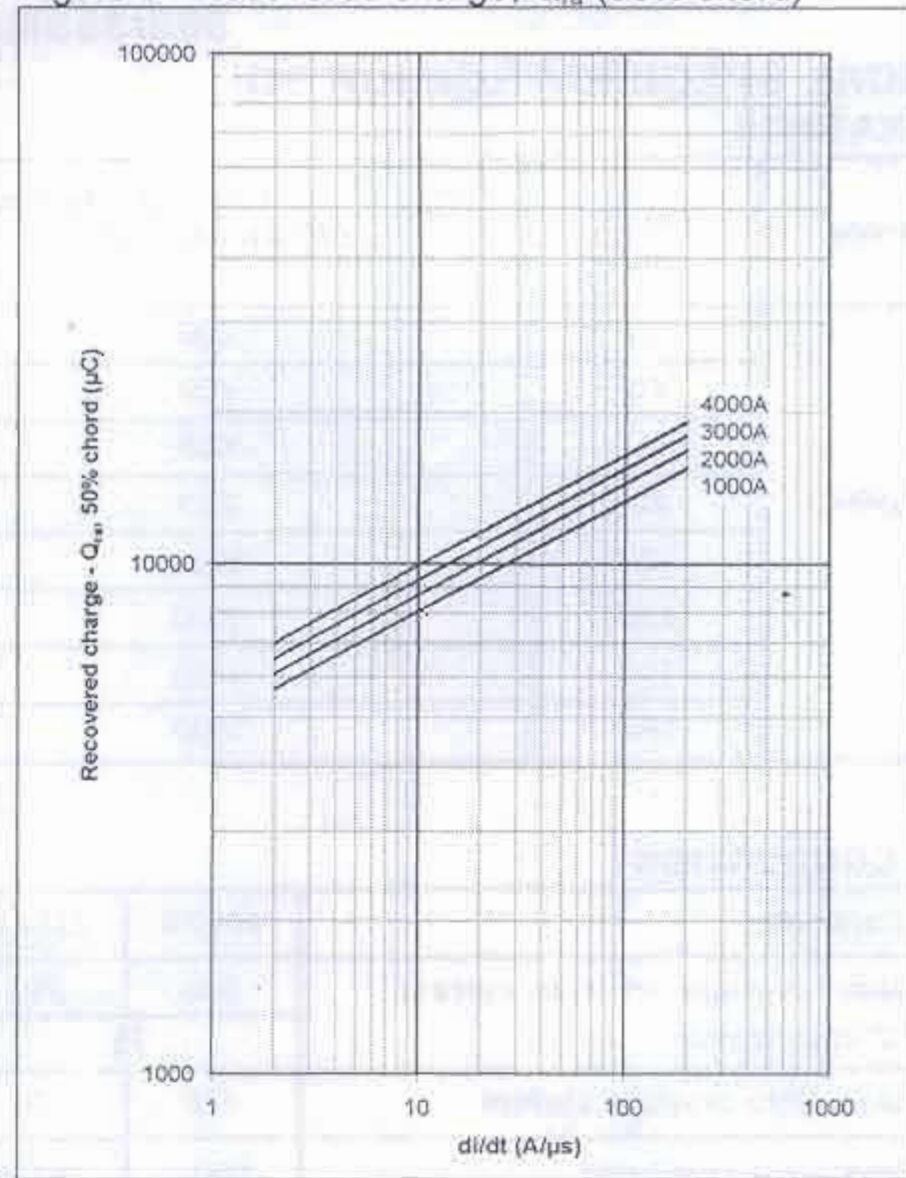


Figure 7 - Peak reverse recovery current, I_{rm}

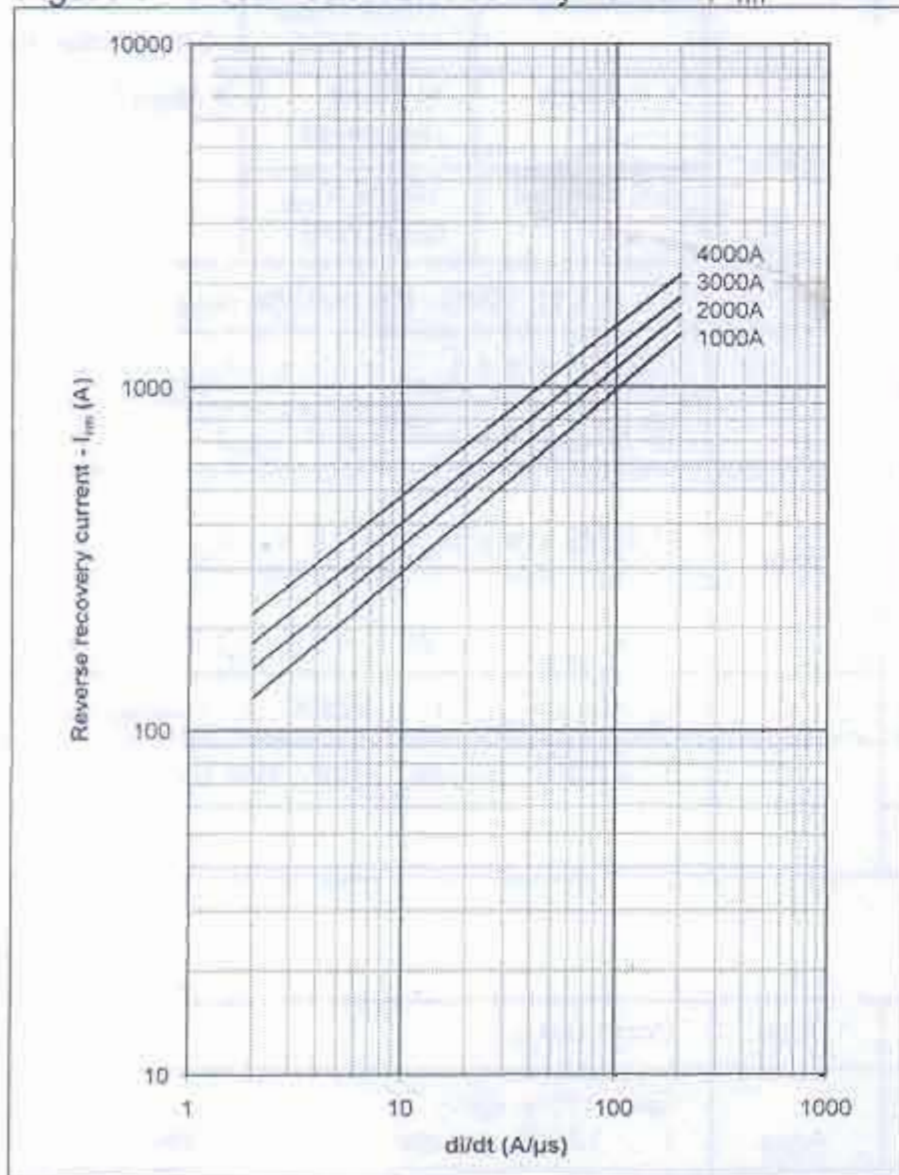
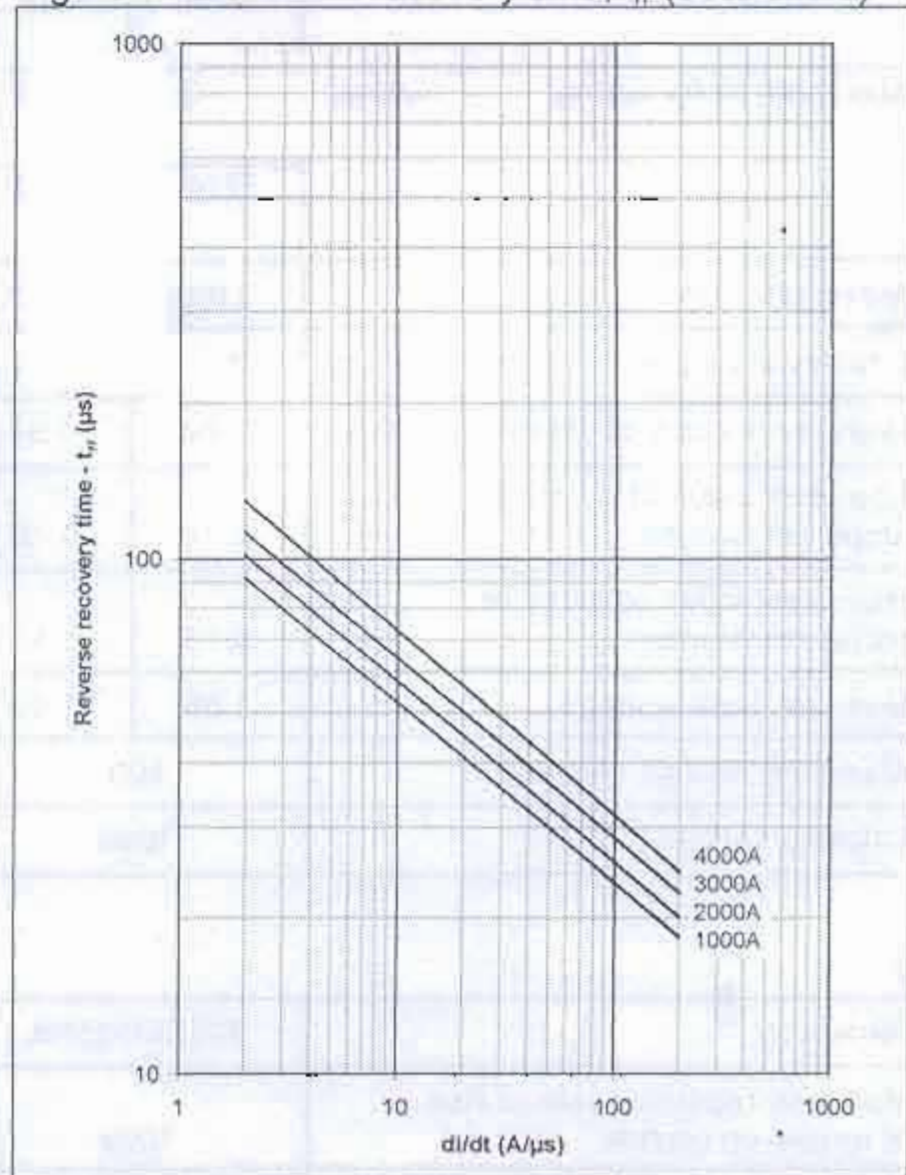


Figure 8 - Maximum recovery time, t_{rr} (50% chord)



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Figure 9 – On-state current vs. Power dissipation – Double Side Cooled (Sine wave)

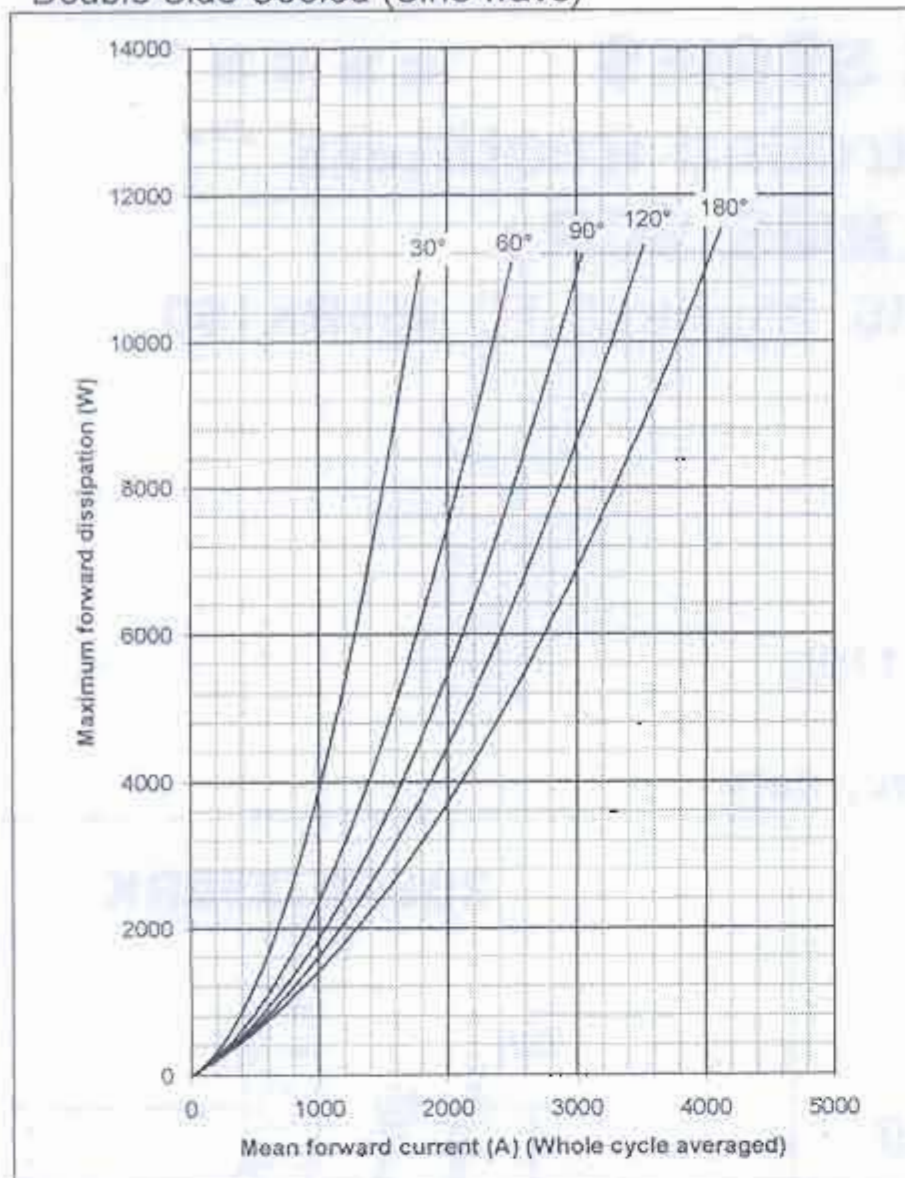


Figure 10 – On-state current vs. Heatsink temperature - Double Side Cooled (Sine wave)

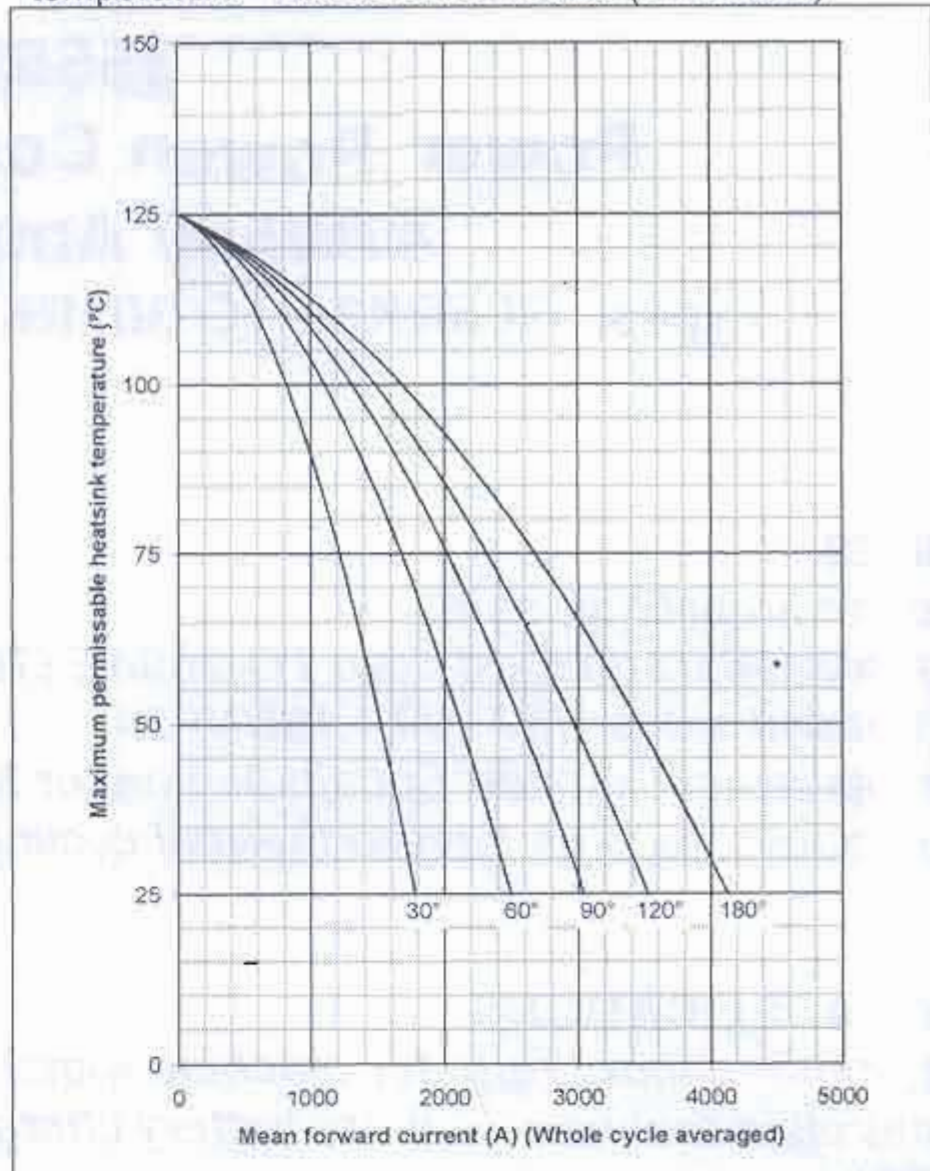


Figure 11 – On-state current vs. Power dissipation – Double Side Cooled (Square wave)

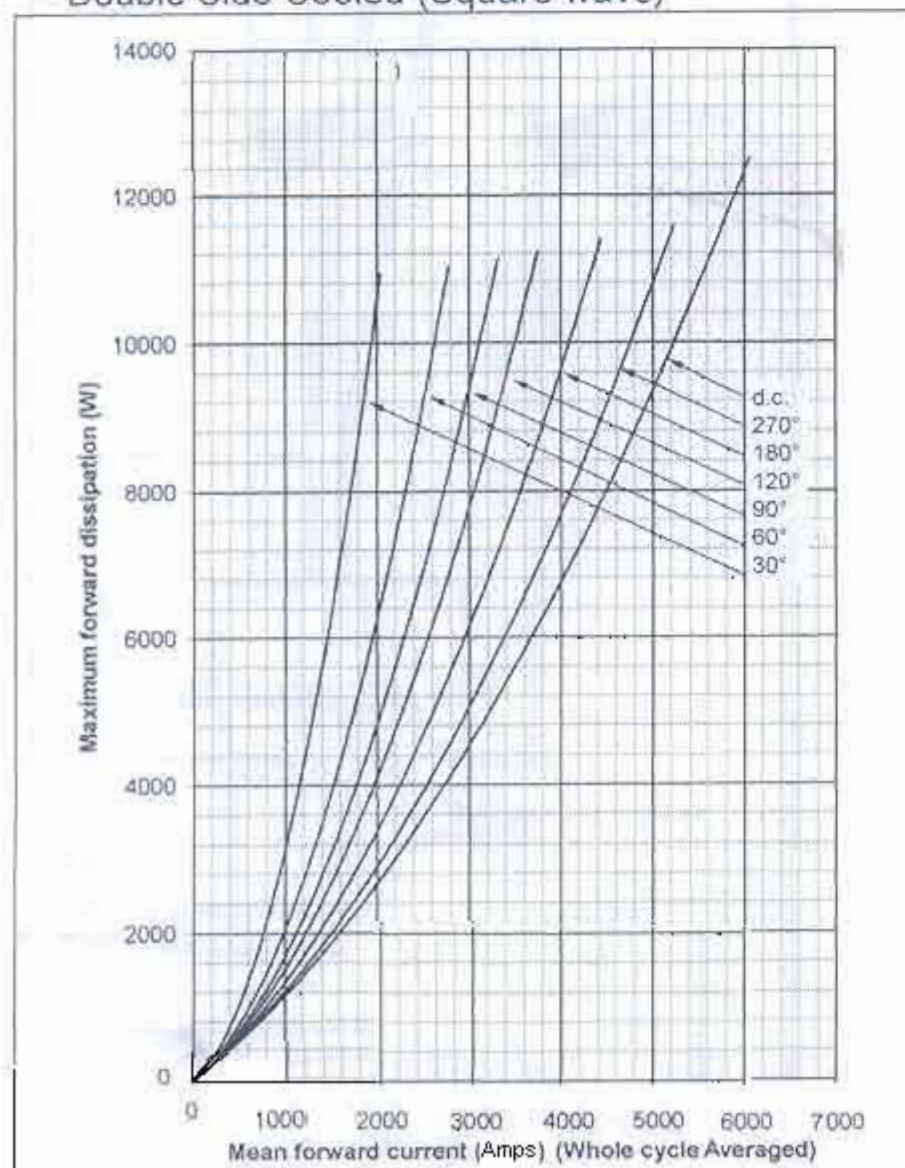
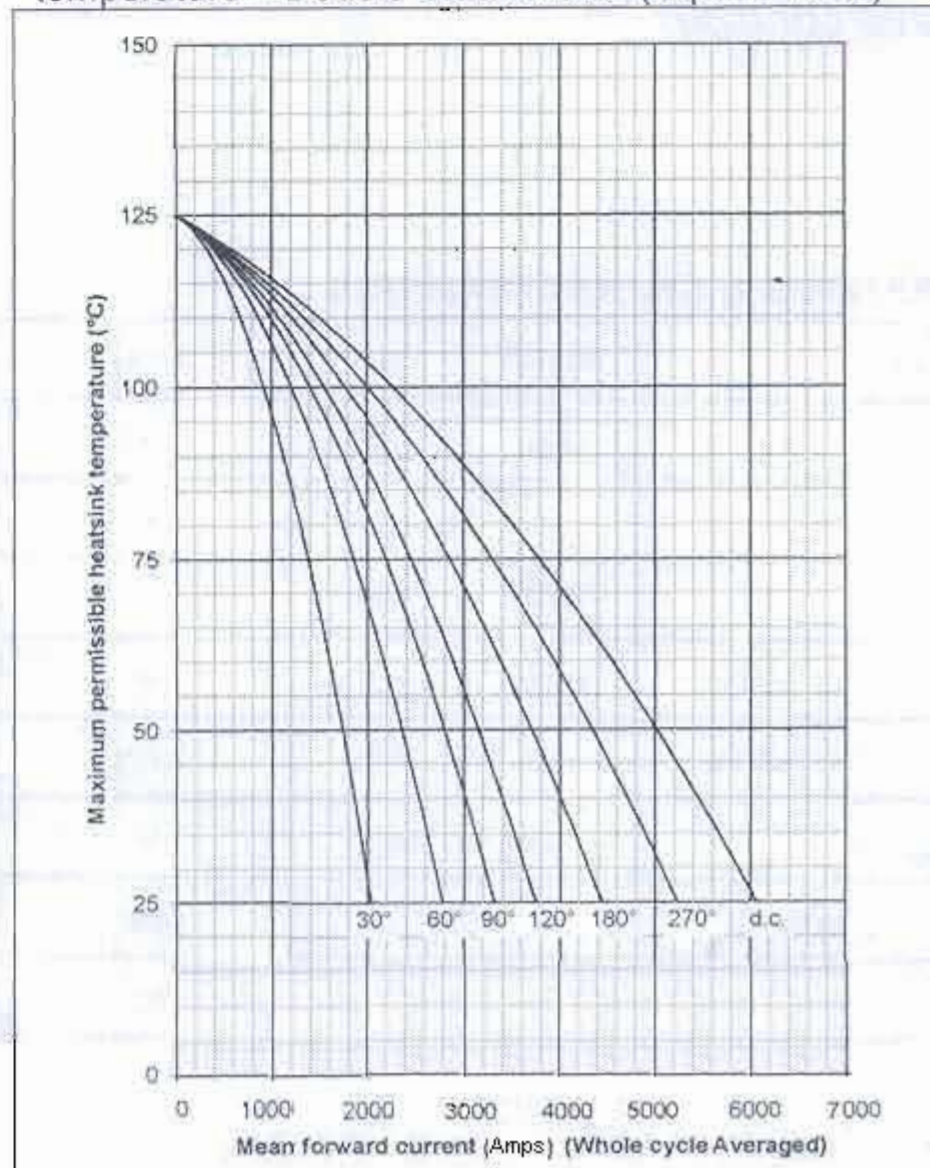


Figure 12 – On-state current vs. Heatsink temperature – Double Side Cooled (Square wave)



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Figure 13 – On-state current vs. Power dissipation
– Single Side Cooled (Sine wave)

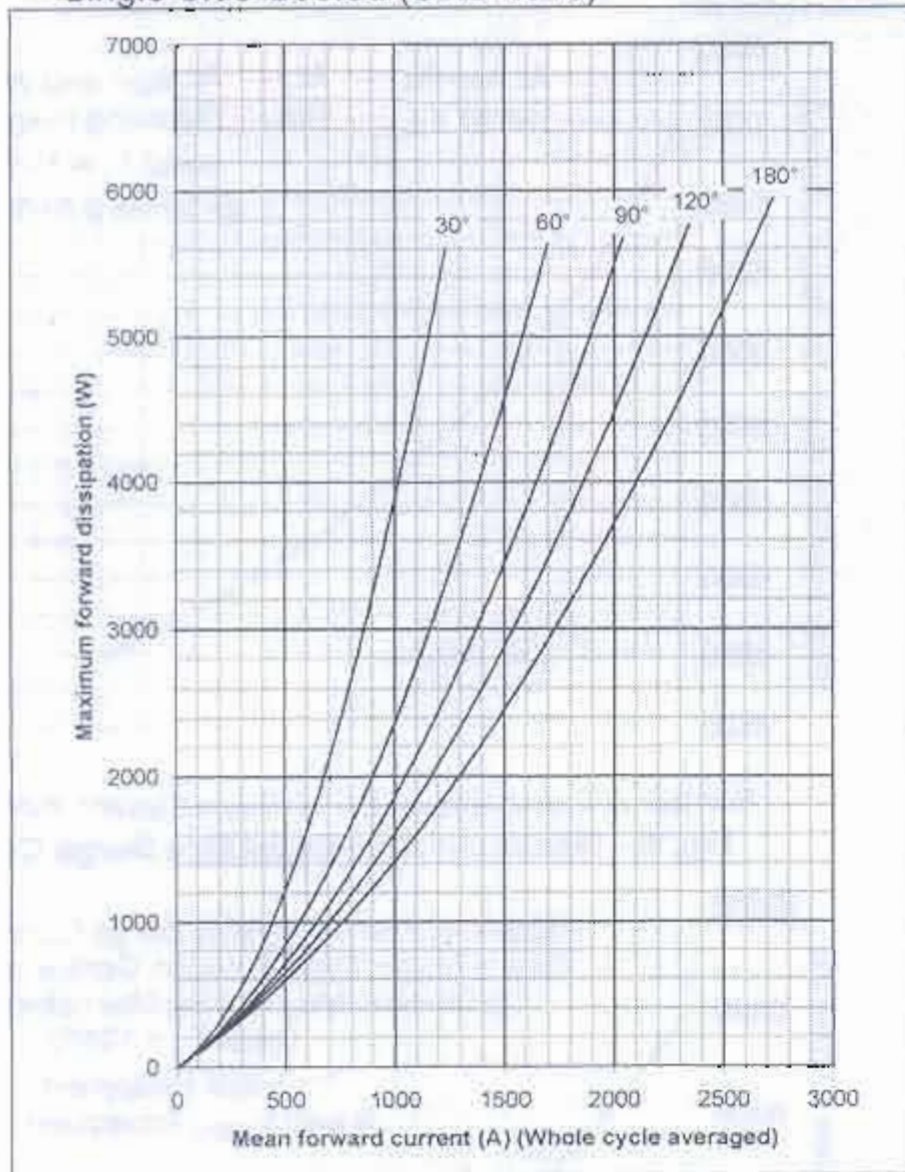


Figure 14 – On-state current vs. Heatsink temperature – Single Side Cooled (Sine wave)

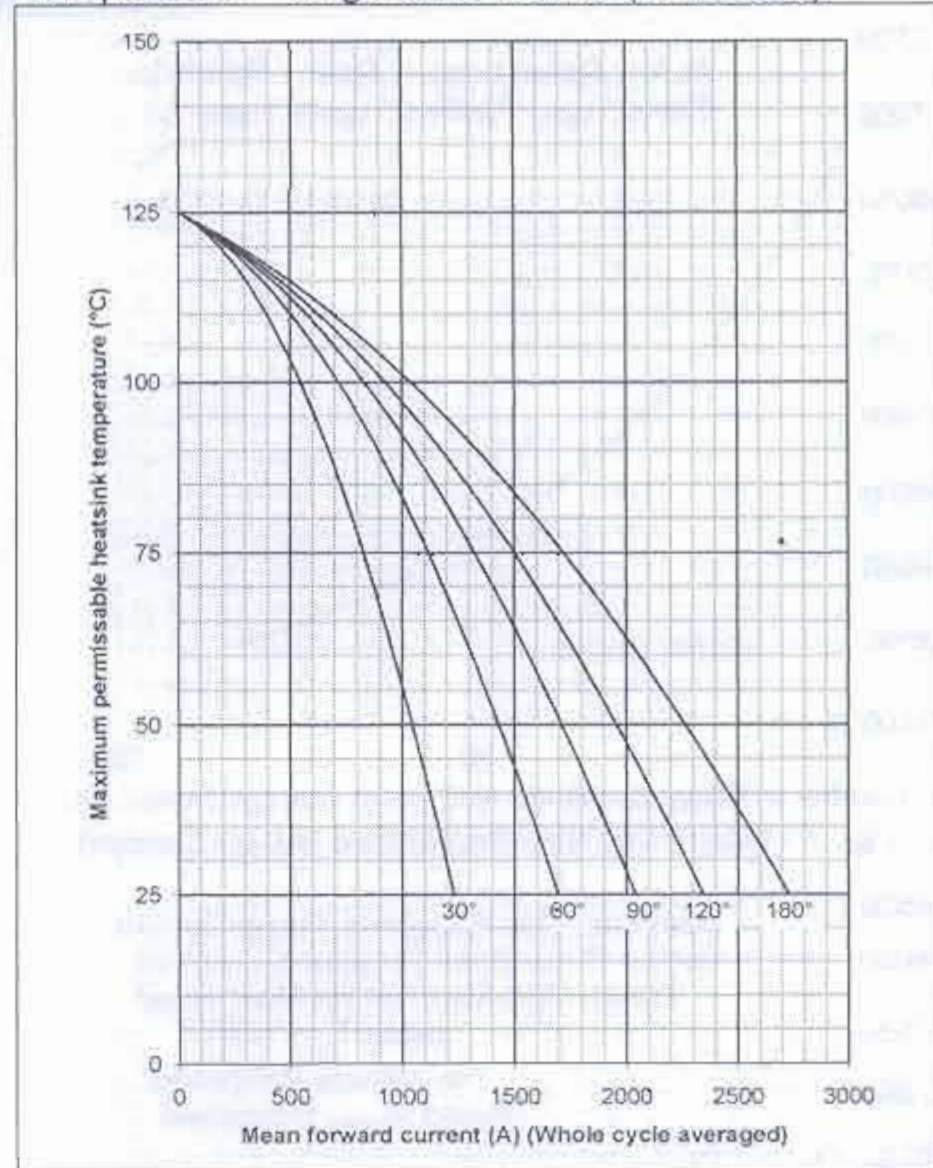


Figure 15 – On-state current vs. Power dissipation
– Single Side Cooled (Square wave)

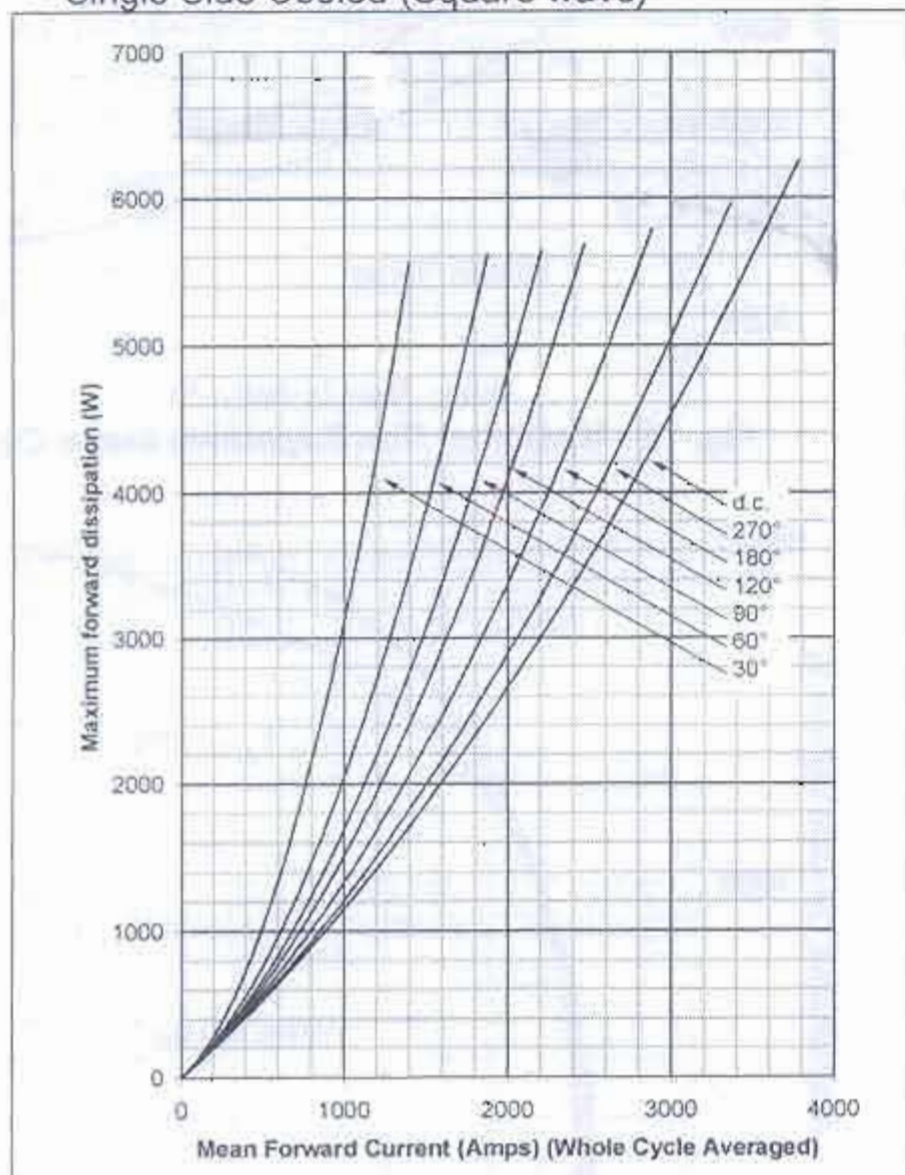
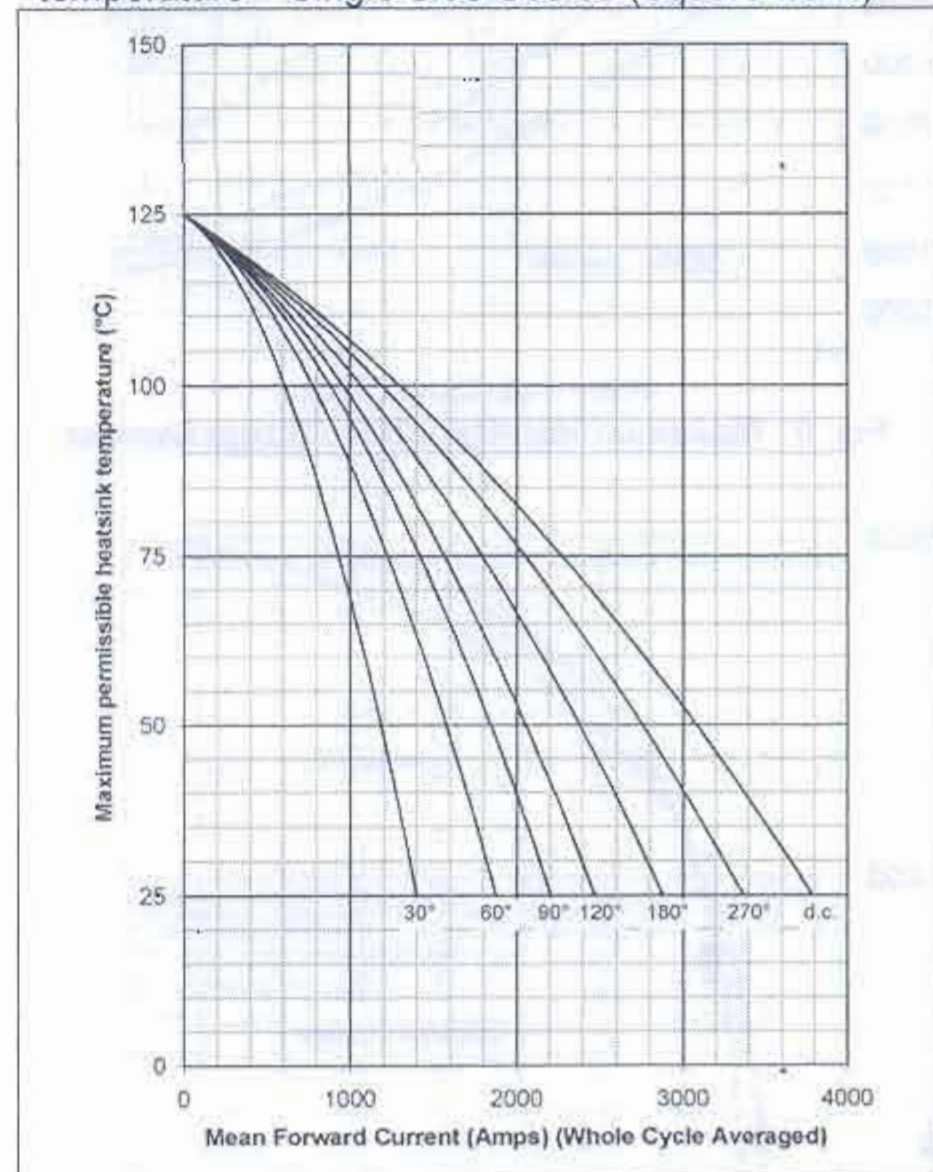


Figure 16 – On-state current vs. Heatsink temperature – Single Side Cooled (Square wave)



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Figure 17 - Maximum surge and I^2t Ratings

